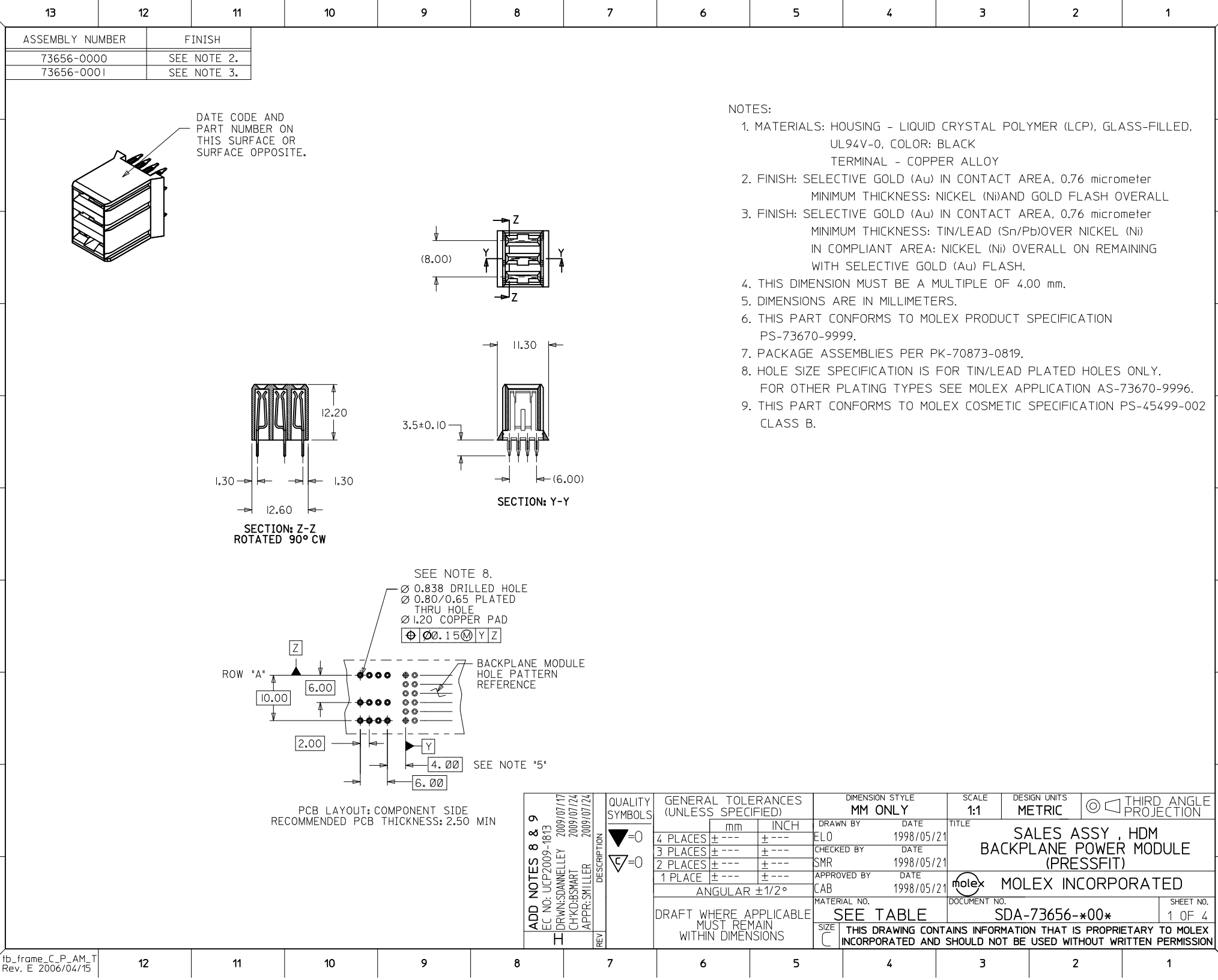




F

E

D

C

B

A

F

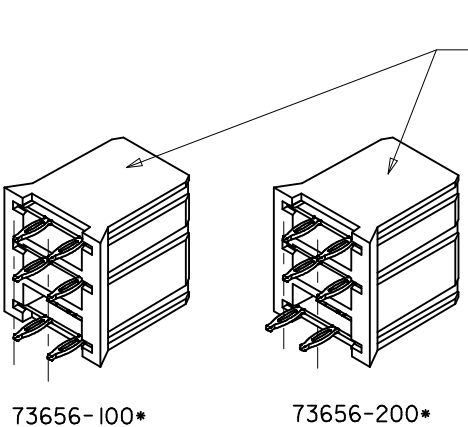
E

D

C

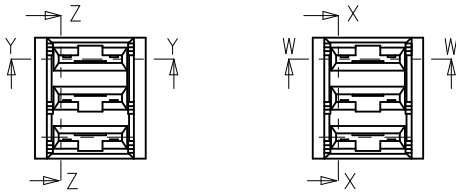
B

A

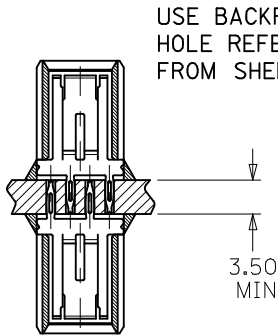


MIDPLANE OPTION

ASSEMBLY NUMBER	FINISH (SEE SHT 1)
73656-1000	SEE NOTE 2. (GOLD TAILS)
73656-2000	
73656-1001	SEE NOTE 3. (TIN/LEAD TAILS)
73656-2001	

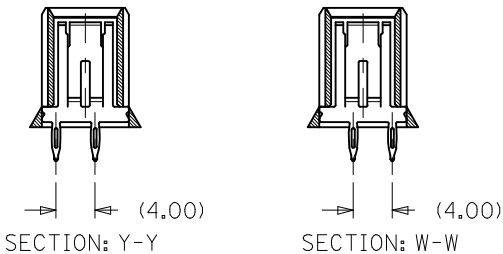
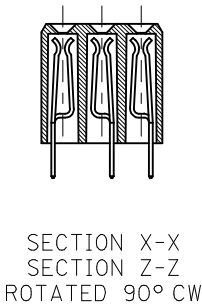


73656-200* 73656-100*



USE BACKPLANE MODULE HOLE REFERENCE PATTERN FROM SHEET 1

BACK-TO-BACK MOUNTING APPLICATION



SEE SHEET 1 EC NO: UCP2009-1813 DRWN:SDANIELLEY 2009/07/17 CHKD:BSMART 2009/07/24 APPR:SMILLER 2009/07/24 REV	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		▽=0 ▽=0			DRAWN BY DATE		TITLE SALES ASSY , HDM BACKPLANE POWER MODULE (PRESSFIT)			
				ELO 1998/05/21						
				CHECKED BY DATE		MOLEX MOLEX INCORPORATED				
				SMR 1998/05/21						
		APPROVED BY DATE		DOCUMENT NO.		SHEET NO.				
		CAB 1998/05/21		MATERIAL NO.		SDA-73656-*00*		2 OF 4		
		ANGULAR ±1/2°		SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS								

ASSEMBLY NUMBER

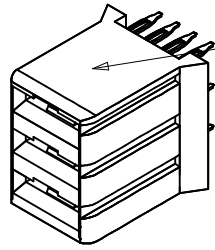
FINISH (SHT I)

73656-5000

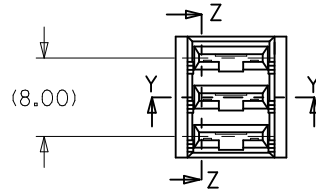
SEE NOTE 2.

73656-5001

SEE NOTE 3.



DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.



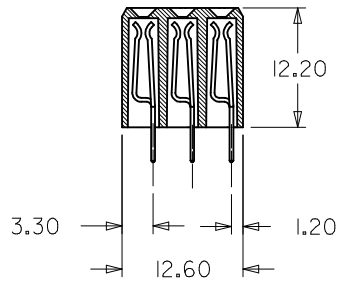
(8.00)

11.30

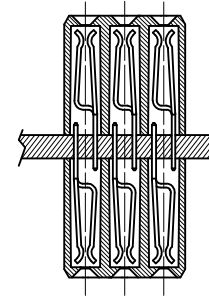
3.5±0.10

(6.00)

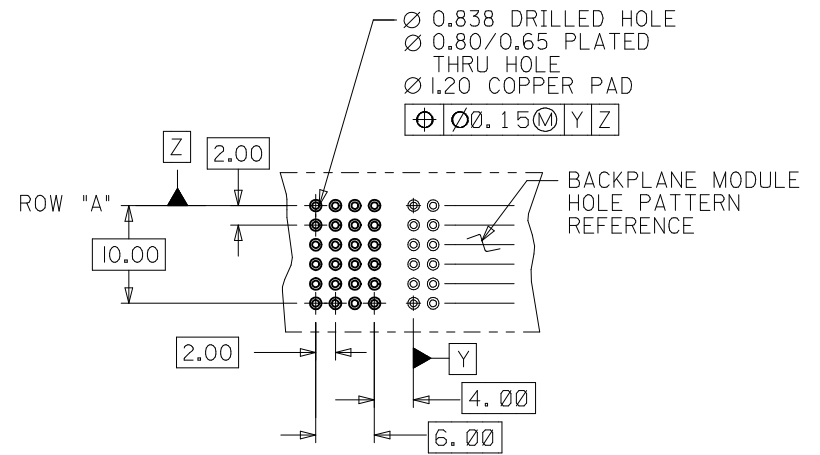
SECTION: Y-Y



SECTION: Z-Z
ROTATED 90° CW



2.36 MIN



SEE SHEET 1
EC NO: UCP2009-1813
DRWN: SDANIELLEY 2009/07/17
CHKD: BSMART 2009/07/24
APPR: SMILLER 2009/07/24

QUALITY
SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR	±1/2°	

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY	DATE
ELO	1998/05/21
CHECKED BY	DATE
SMR	1998/05/21
APPROVED BY	DATE
CAB	1998/05/21

MATERIAL NO.

SEE TABLE

SIZE
BSCALE
1:1DESIGN UNITS
METRICTHIRD ANGLE
PROJECTION

SALES ASSY, HDM
BACKPLANE POWER MODULE
(PRESSFIT)

MOLEX INCORPORATED

DOCUMENT NO.

SDA-73656-*00*

SHEET NO.

3 OF 4

ASSEMBLY NUMBER

FINISH

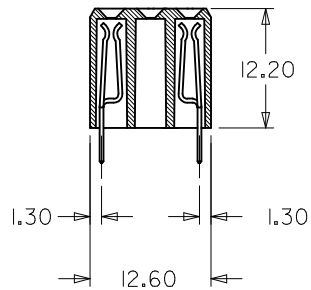
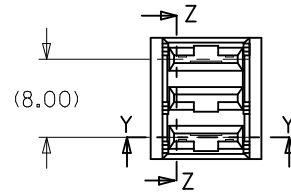
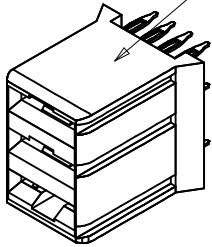
73656-0180

SEE NOTE 2.

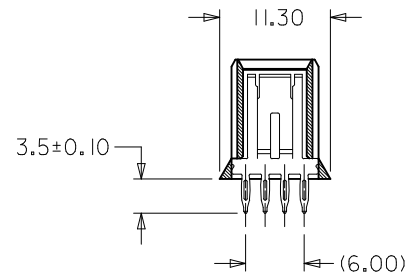
73656-0181

SEE NOTE 3.

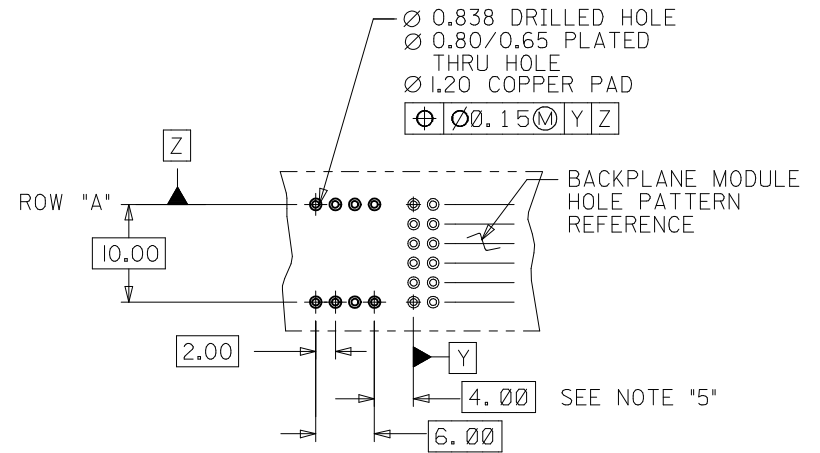
DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.



SECTION: Z-Z
ROTATED 90° CW



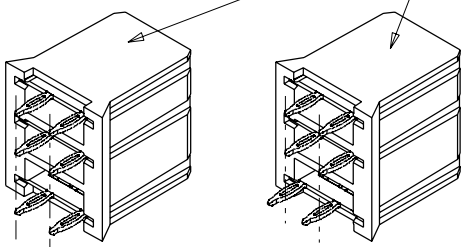
SECTION: Y-Y



PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN

SEE SHEET 1 EC NO: UCP2009-1813 DRWN:SDANIELLEY 2009/07/17 CHKD:SMART 2009/07/24 APPR:SMILLER 2009/07/24	QUALITY SYMBOLS ▽=0 ◻=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION				
				mm	INCH	DRAWN BY	DATE	TITLE SALES ASSY , HDM BACKPLANE POWER MODULE (PRESSFIT)					
			4 PLACES	± ---	± ---	ELO	1998/05/21						
			3 PLACES	± ---	± ---	CHECKED BY	DATE						
			2 PLACES	± ---	± ---	SMR	1998/05/21	MOLEX INCORPORATED					
			1 PLACE	± ---	± ---	APPROVED BY	DATE						
			ANGULAR ±1/2°		CAB	1998/05/21	MOLEX INCORPORATED						
					MATERIAL NO.							DOCUMENT NO.	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SDA-73656-*00*					4 OF 4	
					SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

10 9 8 7 6 5 4 3 2 1

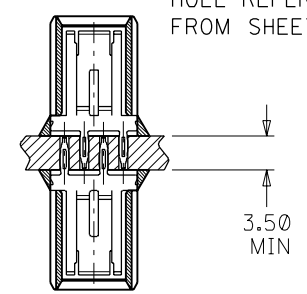


73656-100* 73656-200*

DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.

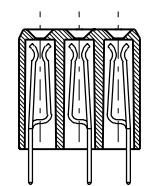
MIDPLANE OPTION

ASSEMBLY NUMBER	FINISH (SEE SHT 1)
73656-1000	SEE NOTE 2. (GOLD TAILS)
73656-2000	
73656-1001	SEE NOTE 3. (TIN/LEAD TAILS)
73656-2001	

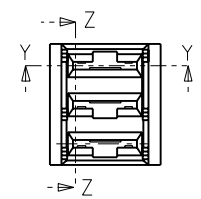


BACK-TO-BACK
MOUNTING APPLICATION

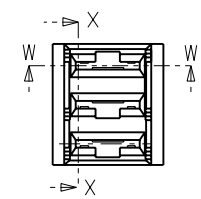
USE BACKPLANE MODULE
HOLE REFERENCE PATTERN
FROM SHEET 1



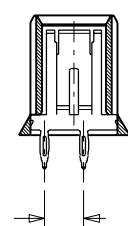
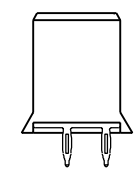
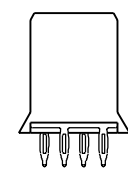
SECTION X-X
SECTION Z-Z
ROTATED 90° CW



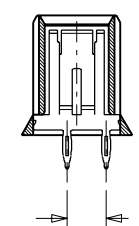
73656-200*



73656-100*



SECTION: Y-Y



SECTION: W-W

F
E
D
C
B
A

F
E
D
C
B
A

				D		SEE SHEET 1	DIMENSIONS SHOWN (METRIC) INCH		REVISE ONLY ON CAD SYSTEM															
				B		SEE SHEET 1	UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°		TITLE SALES ASSY, HDM BACKPLANE POWER MODULE (PRESS FIT)															
				A		SEE SHEET 1	<table><tr><th colspan="2">INCH</th><th>METRIC</th></tr><tr><td>3 PLACE</td><td>± N/A</td><td>---</td></tr><tr><td>2 PLACE</td><td>± N/A</td><td>± ---</td></tr><tr><td>1 PLACE</td><td>---</td><td>± ---</td></tr></table>		INCH		METRIC	3 PLACE	± N/A	---	2 PLACE	± N/A	± ---	1 PLACE	---	± ---	moLEX MOLEX INCORPORATED LISLE, ILL. 60532 U.S.A.			
INCH		METRIC																						
3 PLACE	± N/A	---																						
2 PLACE	± N/A	± ---																						
1 PLACE	---	± ---																						
							DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SHEET NO. 2 DATE 98/05/21															
							<table><tr><td>DRWG. BY</td><td>ELO</td><td>CHK'D. BY</td><td>SMR</td></tr><tr><td>APP'D. BY</td><td>CAB</td><td>SCALE</td><td>2 : 1</td></tr></table>		DRWG. BY	ELO	CHK'D. BY	SMR	APP'D. BY	CAB	SCALE	2 : 1	PART NO. SEE CHART SDA-73656-*00*							
DRWG. BY	ELO	CHK'D. BY	SMR																					
APP'D. BY	CAB	SCALE	2 : 1																					
LTR.				REVISIONS		LTR.	REVISIONS		FILE NAME S73656X2 DGN		DIV. DA SIZE B													
									THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.															

10 9 8 7 6 5 4 3 2 1

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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